

**The 23th IMPACT Conference
Is now Calling For Papers til June. 15th!!
A global platform with integral outstanding expertise in
packaging and PCB professionals**

IMPACT 2017 Conference, which is the largest gathering of packaging and PCB professionals in Taiwan, is going to be held on Oct. 25th-27th at Taipei Nangang Exhibition Center. This conference is organized by IEEE CPMT-Taipei, iMAPS-Taiwan, ITRI and TPCA, and it always attracts not only academic but also industrial experts coming to join this grand conference. It is the best platform to gather all professional prospects globally. Furthermore, conference keeps collaborating with international organizations, such as ICEP from Japan and iNEMI from U.S.A., and it will also be held in conjunction with TPCA SHOW 2017 at the same period. Therefore, a valuable influence toward future trends that will shape the platform of high-tech industry and academic research is going to be built in this grand international conference.

With regard to the committees of conference, they are not only come from high-tech industries but also academic circles as well as research institute. For grasping the latest trend, the IMPACT highlights the theme **“IMPACT on Intelligent Everything”** toward intelligent innovations, which fall into several areas: smart application, robot, drones, autonomous vehicles, artificial intelligence and IoT devices. Its technologies apply to not only intelligent manufacturing and high-speed interconnect technology for server, but also advanced technologies for packaging as well as fan-out. This symposium successfully gathers a great number of global manufacturers join to present their research and development every year, such as TSMC, Intel, IBM, SPIL, ASE, Dow chemical and Atotech etc..

IMPACT kindly welcomes all the industrial experts and researchers to submit their papers. The conference collects numbers of papers from 18 different countries and record more than 200 speeches every year. Moreover, for enterprises which are looking for enhancing company identity and technological strength, IMPACT is available for corporative sponsorship.

Please visit our official website for more information: www.impact.org.tw
Or kindly contact IMPACT secretariat Kristy: +886-3-3815659 #405 °

【日期】 2017 年 10 月 25 (三) 到 10 月 27(五)

【Date】 Oct 25th (Wed) to Oct. 27th (Fri), 2017

【Venue】 Taipei Nangang Exhibition Center

【Theme】 IMPACT on Intelligent Everything

【Exhibition】 TPCA Show 2017

【On-line Submission】 www.impact.org.tw

【Important Date】

Item	Date	Remark
Abstract Submission Deadline	June 15, 2017	400-500 words Submit on-line www.impact.org.tw
Abstract Acceptance Notification	July 15, 2017	Notice sent via email
Full Paper Submission (Camera-ready Version)	August 25, 2017	4 pages including figures and tables Submit on-line through conference website and copyright forms due

【Scope of Paper Solicited】

Packaging	PCB
P1. Advanced Packaging Technologies	B1. Green Materials and Process
P2. Power Electronics Packaging	B2. Test, Quality, AOI, Inspection and Reliability
P3. 3D Integration and SiP	B3. HDI and Embedded Technology
P4. Wearable Technologies	B4. Electro Deposition and Electrochemical Processing Technology
P5. Interconnections & Nanotechnology	B5. Advanced and Emerging Technology
P6. Modeling, Simulation & Design	B6. Mechatronics and Automation
P7. Thermal Management	B7. Advanced Materials
P8. Advanced Sensor & Microsystems Technology (MST)	
P9. Advanced Materials, Automatic Process & Assembly	
P10. Emerging Systems Packaging Technologies	



IMPACT Website

【Contact us】

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